PCGLA200T75NF8

750 V, 200 A Field Stop Trench IGBT Die

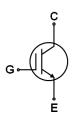


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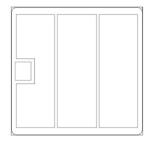
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V_{CES} = 750 V I_C = Limited by T_{i(max)}

IGBT DIE



DIE OUTLINE



ORDERING INFORMATION

Device	Inking?	Shipping
PCGLA200T75NF8	Yes	Sawn Wafer on Tape

Features

- AEC-Q101 Rev. D Qualified for Enhanced Reliability
- Maximum Junction Temperature 175°C
- Advanced FS4 Trench Technology
- Positive Temperature Coefficient
- Easy Paralleling
- Short Circuit Rated
- Very Low Saturation Voltage: $V_{CE(SAT)} = 1.45 \text{ V(Typ.)}@I_C = 200 \text{ A}$
- Optimized for Motor Control Applications

Applications

- Automotive Traction Modules
- General Power Modules

MECHANICAL PARAMETERS

Parameter	Mils	μm			
Die Size	394 x 394	10,000 x 10,000			
Emitter Pad Size	See chip drawing	See chip drawing			
Gate Pad Size	47 x 56	1,200 x 1,430			
Scribe Lane Width	3	80			
Die Thickness	3.4	86			
Top Metal	5 μm AlSiCu				
Back Metal	1.3 μm Al/NiV/Ag				
Topside Passivation	Silicon Nitride plus Polyimide				
Wafer Diameter	200 mm				
Max Possible Die Per Wafer	226				
Recommended Storage Environment	In original container, in dry nitrogen, < 3 months at an ambient temperature of 23°C				

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ABSOLUTE MAXIMUM RATINGS (T_{VJ}= 25°C Unless Otherwise Noted)

Parameter	Symbol	Ratings	Unit	
Collector-Emitter Voltage	V _{CES}	750	V	
Gate-Emitter Voltage	V _{GES}	±20	V	
DC Collector Current, limited by T _{VJ} max	I _C	(Note 1)	Α	
Pulsed Collector Current, V _{GE} = 15 V, tp limited by T _{VJ max} (Note 2)	I _{CM}	600	Α	
Short Circuit Withstand Time, V_{GE} = 15 V, V_{CE} ≤ 400 V, T_{VJ} ≤ 175°C	t _{sc}	4	μs	
Operating Junction Temperature	T _{VJ}	-40 to +175	°C	
Storage Temperature Range	Tstg	-17 to +25	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Depends on the thermal properties of assembly.

- 2. Not subject to production test verified by design/characterization.

Parameter	Symbol	Test Conditions		Min.	Тур.	Max.	Unit
STATIC CHARACTERISTICS (Tested or	n wafers)	<u> </u>			1 7	<u> </u>	
Collector-Emitter Breakdown Voltage	BV _{CES}	V _{GE} = 0 V, I _C = 1 mA		750	_	-	V
Collector-Emitter Saturation Voltage	V _{CE(SAT)}	I _C = 200 A	, V _{GE} = 15 V	_	1.45	1.75	V
Gate-Emitter Threshold Voltage	V _{GE(th)}	V _{GE} = V _{CE}	, I _C = 200 mA	4.3	5.5	6.7	V
Collector Cut-off Current	I _{CES}	$V_{CE} = V_{CES}$, $V_{GE} = 0 \text{ V}$		_	-	40	μΑ
Gate Leakage Current	I _{GES}	V _{GE} = V _{GES} , V _{CE} = 0 V		_	-	±400	nA
ELECTRICAL CHARACTERISTICS (No	t subjected to	production test	 verified by desig 	n/charact	erization)		
Collector-Emitter Breakdown Voltage	BV _{CES}	V _{GE} = 0 V, I _C = 1 mA	T _{VJ} =-40°C	700	820	-	V
Collector Cut-off Current	I _{CES}	V _{CE} = V _{CES} ,	T _{VJ} = 150°C	_	0.2	-	mA
		V _{GE} = 0 V	T _{VJ} = 175°C	_	1.5	-	
Collector-Emitter Saturation Voltage	V _{CE(SAT)}	I _C = 200A, V _{GE} = 15 V	T _{VJ} = 150°C	-	1.65	-	V
			T _{VJ} = 175°C	-	1.7	-	1
Input Capacitance	C _{IES}	$V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}, f = 1 \text{ MHz}$ $f = 1 \text{ MHz}$		-	19900	-	pF
Output Capacitance	C _{OES}			_	374	-	pF
Reverse Transfer Capacitance	C _{RES}			-	64	-	pF
Internal Gate Resistance	R _G			_	10	-	Ω
Total Gate Charge	Q _{G(Total)}	V_{CE} = 400 V, I_{C} = 200 A, V_{GE} = -8 V to +15 V		=	718	-	nC
Gate-Emitter Charge	Q_{GE}			=	385	-	
Gate-Collector Charge	Q _{GC}			=	152	-	
Turn-On Delay Time	t _{d(on)}	V _{CE} = 400 \	V, I _C = 200 A,	_	257.0	-	nS
Rise Time	t _r	$R_G = 2 \Omega$, $V_{GE} = \pm 15 / -8 V$, Inductive Load, $T_{VJ} = 25^{\circ}C$		=	202.0	-	
Turn-Off Delay Time	t _{d(off)}			_	247.5	_	
Fall Time	t _f			_	163.0	_	
Turn-On Delay Time	t _{d(on)}	$V_{CE} = 400 \text{ V, } I_{C} = 200 \text{ A,}$ $R_{G} = 2 \Omega, V_{GE} = \pm 15 / -8 \text{ V,}$ Inductive Load, $T_{VJ} = 150^{\circ}\text{C}$		_	273.5	_	nS
Rise Time	t _r			_	214.5	_	
Turn-Off Delay Time	t _{d(off)}			_	280.5	_	
Fall Time	t _f			_	247.5	-	

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ELECTRICAL CHARACTERISTICS (T_J= 25°C Unless Otherwise Noted) (continued)

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit		
ELECTRICAL CHARACTERISTICS (Not subjected to production test – verified by design/characterization)								
Turn-On Delay Time	t _{d(on)}	$V_{CE} = 400 \text{ V}, I_{C} = 200 \text{ A},$ $R_{G} = 2 \Omega, V_{GE} = \pm 15 / -8 \text{ V},$	_	282.0	_	nS		
Rise Time	t _r	Inductive Load,	_	227.0	-			
Turn-Off Delay Time	t _{d(off)}	T _{VJ} = 175°C	_	289.0	_			
Fall Time	t _f		_	269.0	-			

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

Switching characteristics and thermal properties are depending strongly on module design and mounting technology.

For ordering, technique and other information on ON Semiconductor automotive bare die products, please contact automotivebaredie@onsemi.com.

Die Layout

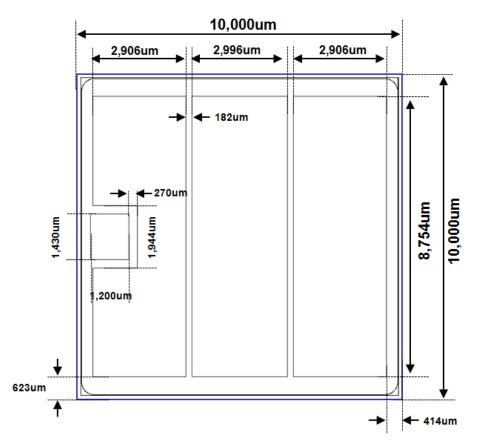


Figure 1. Die Layout

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